

Title (en)
CAPACITOR ARRANGEMENT

Title (de)
KONDENSATORANORDNUNG

Title (fr)
ENSEMBLE CONDENSATEUR

Publication
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Application
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Abstract (en)
[origin: WO2014135340A1] The invention relates to a capacitor arrangement comprising at least one ceramic multi-layer capacitor (1) which has a base body (2) comprising ceramic layers (3) and first and second electrode layers (41, 42) arranged there between, and a first external contact (51) and a second external contact (52) on lateral surfaces (61, 62) being opposite to one another, wherein the first external contact (51) is connected in an electrically conductive manner to the first electrode layers (41) and the second external contact (52) to the second electrode layers (42), and comprising a contact arrangement (7) having two metallic contact plates (70), between which the at least one ceramic multi-layer capacitor (1) is arranged, wherein the first and the second external contact (51, 52) is connected in each case to one of the metallic contact plates (70) in an electrically conductive manner.

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